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June 2001 Revised September 2004

NC7SZ332

TinyLogic® UHS 3-Input OR Gate

General Description

The NC7SZ332 is a single 3-Input OR Gate from Fairchild's Ultra High Speed Series of TinyLogic®. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad V_{CC} operating range. The device is specified to operate over the 1.65V to 5.5V $V_{\mbox{\footnotesize CC}}$ range. The inputs and output are high impedance when $V_{\mbox{\footnotesize CC}}$ is 0V. Inputs tolerate voltages up to 7V independent of V_{CC} operating voltage.

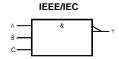
Features

- Space saving SC70 6-lead package
- Ultra small MicroPak™ leadless package
- Ultra high speed t_{PD} 2.4 ns Typ into 50 pF at 5V V_{CC}
- High output drive ±24 mA at 3V V_{CC}
- Broad V_{CC} operating range 1.65V to 5.5V
- Power down high impedance inputs/output
- Overvoltage tolerant inputs facilitate 5V to 3V translation
- Patented noise/EMI reduction circuitry implemented

Ordering Code:

Order Number Package Number		Product Code Top Mark	Package Description	Supplied As	
NC7SZ332P6X	MAA06A	332	6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel	
NC7SZ332L6X	MAC06A	F3	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel	

Logic Symbol



Pin Descriptions

Pin Names	Description
A, B, C	Inputs
Y	Output

Function Table

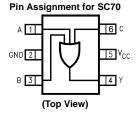
$$Y = A + B + C$$

	Output		
Α	В	С	Y
Н	Х	Х	Н
X	Н	X	Н
X	X	Н	Н
L	L	L	L

H = HIGH Logic Level

- L = LOW Logic Level X = Either LOW or HIGH Logic Level

Connection Diagrams

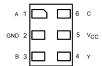


Pin One Orientation Diagram



AAA represents Product Code Top Mark - see ordering code Note: Orientation of Top Mark determines Pin One location. Read the Top Product Code Mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignment for MicroPak



(Top Thru View)

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Absolute Maximum Ratings(Note 1)

-0.5Vto +7.0V Supply Voltage (V_{CC}) -0.5V to +7.0V DC Input Voltage (V_{IN}) DC Output Voltage (V_{OUT}) -0.5V to +7.0VDC Input Diode Current (I_{IK}) $@V_{IN} < -0.5V$ -50 mA +20 mA @V_{IN} >6V DC Output Diode Current (I_{OK})

 $@V_{OUT} < -0.5V$ -50 mA $@V_{OUT} > 6V, (V_{CC} = GND)$ +20 mA DC Output Current (I_{OUT}) $\pm 50~\text{mA}$ DC V_{CC} /GND Current (I_{CC} / I_{GND}) ±50 mA Storage Temperature (T_{STG}) -65°C to +150°C

Junction Temperature under Bias (T_J) 150°C

Junction Lead Temperature (T_L) ;

Soldering, 10 seconds 260°C

Power Dissipation (PD) @ +85°C

SC70-5 150 mW

Recommended Operating Conditions (Note 2)

Supply Voltage Operating (V_{CC}) 1.65V to 5.5 Supply Voltage Data Retention (V_{CC}) 1.5V to 5.5V Input Voltage (V_{IN}) $\ensuremath{\text{OV}}$ to $5.5\ensuremath{\text{V}}$ Output Voltage (V_{OUT}) 0V to V_{CC} Operating Temperature (T_A) -40°C to +85°C Input Rise and Fall Time $(t_r,\,t_f)$ $V_{CC}=1.8V,\,2.5V\pm0.2V$ 0 ns/V to 20 ns/V $V_{CC}=3.3V\pm0.3V$ 0 ns/V to 10 ns/V

 $V_{CC} = 5.0V \pm 0.5V$ 0 ns/V to 5 ns/V

Thermal Resistance (θ_{JA})

SC70-5 425°C/W

Note 1: Absolute Maximum Ratings are DC values beyond which the device may be damaged or have its useful life impaired. The datasheet specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside datasheet specifications.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

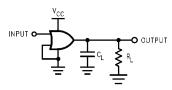
Symbol	Parameter	V _{CC}		$T_A = +25^{\circ}C$		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	
Syllibol	Farameter	(V)	Min	Тур	Max	Min	Max	Units	Coi	iditions
V _{IH}	HIGH Level Input Voltage	1.8 ± 0.15	0.75 V _{CC}			0.75 V _{CC}		٧		
		2.3 to 5.5	0.7 V _{CC}			0.7 V _{CC}		V		
V _{IL}	LOW Level Input Voltage	1.8 ± 0.15			0.25 V _{CC}		0.25 V _{CC}	V		
		2.3 to 5.5			$0.3\mathrm{V}_{\mathrm{CC}}$		$0.3\mathrm{V}_{\mathrm{CC}}$	V		
V _{OH}	HIGH Level Output Voltage	1.65	1.55	1.65		1.55				
		2.3	2.2	2.3		2.2			V V	$I_{OH} = -100 \mu A$
		3.0	2.9	3.0		2.9			vIV – vIH	ΙΟΗ = -100 μΑ
		4.5	4.4	4.5		4.4				
		1.65	1.29	1.52		1.29		V		$I_{OH} = -4 \text{ mA}$
		2.3	1.9	2.15		1.9				$I_{OH} = -8 \text{ mA}$
		3.0	2.4	2.80		2.4				$I_{OH} = -16 \text{ mA}$
		3.0	2.3	2.68		2.3				$I_{OH} = -24 \text{ mA}$
		4.5	3.8	4.20		3.8				$I_{OH} = -32 \text{ mA}$
V _{OL}	LOW Level Output Voltage	1.65		0.0	0.1		0.1			
		2.3		0.0	0.1		0.1		$V_{IN} = V_{IL}$	I _{OL} = 100 μA
		3.0		0.0	0.1		0.1		VIN - VIL	100 μΑ
		4.5		0.0	0.1		0.1			
		1.65		0.08	0.24		0.24	V		I _{OL} = 4 mA
		2.3		0.10	0.3		0.3			$I_{OL} = 8 \text{ mA}$
		3.0		0.15	0.4		0.4			$I_{OL} = 16 \text{ mA}$
		3.0		0.22	0.55		0.55			$I_{OL} = 24 \text{ mA}$
		4.5		0.22	0.55		0.55			$I_{OL} = 32 \text{ mA}$
I _{IN}	Input Leakage Current	0 to 5.5			±1		±10	μΑ	$V_{IN} = 5.5V,$	GND
I _{OFF}	Power Off Leakage Current	0.0			1		10	μΑ	V _{IN} or V _{OUT}	-= 5.5V
I _{CC}	Quiescent Supply Current	1.65 to 5.5			2.0		20	μΑ	$V_{IN} = 5.5V,$	GND

AC Electrical Characteristics

Symbol	Parameter	v _{cc}	T _A = +25°C			$T_A = -40^{\circ}C$ to $+85^{\circ}C$		Units	Conditions	Figure
	i diameter	(V)	Min	Тур	Max	Min	Max	Oillio	Conditions	Number
t _{PLH} ,	Propagation Delay	1.8 ± 0.15	2.0	6.5	18.5	2.0	19.0			
t _{PHL}		2.5 ± 0.2	8.0	3.0	11.0	0.8	11.5	ns	$C_L = 15 pF,$	Figures 1, 3
		3.3 ± 0.3	0.5	2.4	7.5	0.5	8.0	115	$R_L = 1M\Omega$	
		5.0 ± 0.5	0.5	1.9	5.5	0.5	6.0			
t _{PLH} ,	Propagation Delay	3.3 ± 0.3	1.5	3.0	8.5	1.5	9.0	ns	$C_L = 50 \text{ pF},$	Figures
t _{PHL}		5.0 ± 0.5	8.0	2.4	7.0	0.8	7.5	115	$R_L = 500\Omega$	1, 3
C _{IN}	Input Capacitance	0		4				pF		
C _{PD}	Power Dissipation	3.3		20				pF	(Note 3)	Figure 2
	Capacitance	5.0		26				ы	(Note 3)	i iguie z

Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2.) C_{PD} is related to I_{CCD} dynamic operating current by the expression:
I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC}static).

AC Loading and Waveforms



 $\mathbf{C}_{\mathbf{L}}$ includes load and stray capacitance.

Input PRR = 1.0 MHz, $t_{\rm W}$ = 500 ns.

FIGURE 1. AC Test Circuit



Input = AC Waveforms; $t_r = t_f = 1.8 \text{ ns};$

PRR = 10 MHz; Duty Cycle = 50%

FIGURE 2. I_{CCD} Test Circuit

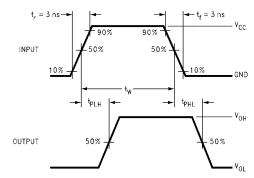


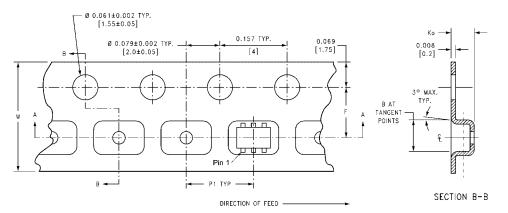
FIGURE 3. AC Waveforms

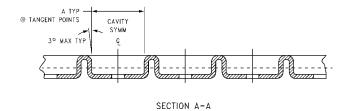
Tape and Reel Specification

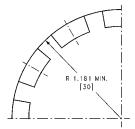
TAPE FORMAT for SC70

1711 = 1 0111111711 101 0	TALE FORMING TO COTO									
Package	Tape	Number	Cavity	Cover Tape						
Designator	Section	Cavities	Status	Status						
	Leader (Start End)	125 (typ)	Empty	Sealed						
P6X	Carrier	3000	Filled	Sealed						
	Trailer (Hub End)	75 (typ)	Empty	Sealed						

TAPE DIMENSIONS inches (millimeters)







BEND RADIUS NOT TO SCALE

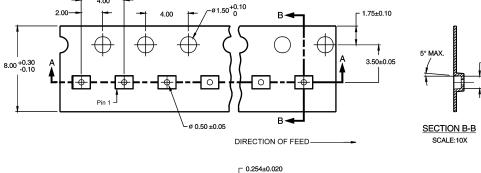
Package	Tape Size	DIM A	DIM B	DIM F	DIM K _o	DIM P1	DIM W
SC70-6	8 mm	0.093	0.096	0.138 ± 0.004	0.053 ± 0.004	0.157 0.315 ± 0.0	0.315 ± 0.004
	0 111111	(2.35)	(2.45)	(3.5 ± 0.10)	(1.35 ± 0.10)	(4)	(8 ± 0.1)

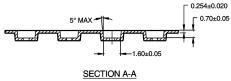
1.15±0.05

Tape and Reel Specification (Continued)

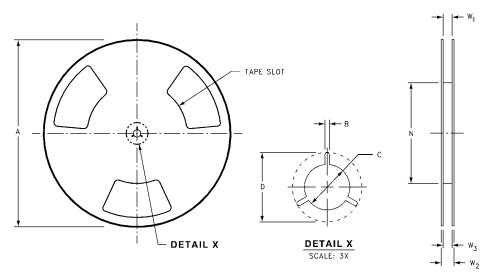
TAPE FORMAT for MicroPak

Package	Tape	Number	Cavity	Cover Tape	
Designator	Section	Cavities	Status	Status	
	Leader (Start End)	125 (typ)	Empty	Sealed	
L6X	Carrier	5000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	



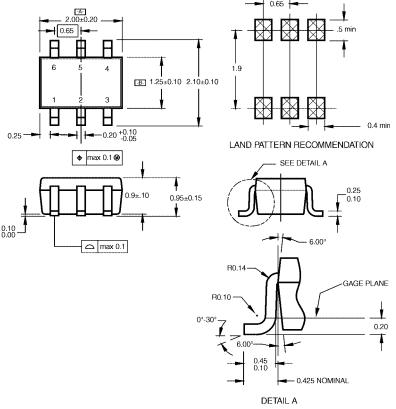


REEL DIMENSIONS inches (millimeters)



Tape Size	Α	В	С	D	N	W1	W2	W3
0	7.0	0.059	0.512	0.795	2.165	0.331 + 0.059/-0.000	0.567	W1 + 0.078/-0.039
8 mm	(177.8)	(1.50)	(13.00)	(20.20)	(55.00)	(8.40 + 1.50/-0.00)	(14.40)	(W1 + 2.00/-1.00)

Physical Dimensions inches (millimeters) unless otherwise noted



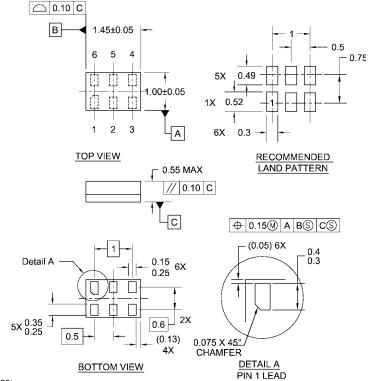
NOTES:

- A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88.
- B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
- C. DIMENSIONS ARE IN MILLIMETERS.

6-Lead SC70, EIAJ SC88, 1.25mm Wide Package Number MAA06A

MAA06ARevC

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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